

MHF® 4L Connector

Plug Part No. 20565-001R-13, 20572-001R-08 Receptacle Part No. 20579-001E, 20579-001E-01

Product Specification

Qualification Test Report No. TR-14097

7	S21510	October 22, 2021	K. Ikeshita		M. Takemoto
6	S21315	July 2, 2021	N. Miyashiro	K. Ikeshita	M. Takemoto
5	S21182	April 20, 2021	N. Miyashiro	K. Ikeshita	M. Takemoto
4	S20207	April 1, 2020	K. Ikeshita	J. Tonai	Y. Hashimoto
Rev.	ECN	Date	Prepared by	Checked by	Approved by

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1. Scope

This Product Specification defines the test conditions and the performances of the MHF 4L Connector Test method is complied with "PCI Express® M.2 Electromechanical Specification DRAFT Revision 1.0".

2. Product Name and Parts No.

2.1 Product Name

MHF 4L Connector

2.2 Parts No.

Plug: 20565-001R-13, 20572-001R-08 Receptacle: 20579-001E, 20579-001E-01

3. Rating

3.1 Applicable cable

3.1.1 Part No. 20565-001R-13

(1) Description

 $\label{linerconductor:AWG#32(7/0.08), Silver plating copper wire Dielectric core : Fluoro-plastics , diameter 0.70(\pm0.05)mm \\ Outer conductor : Braid of 0.05mm, diameter 0.93(\pm0.09)mm \\ ,$

silver plating copper wire or tin plating copper wire

Jacket : Fluoro-plastics , diameter 1.13(+0.08,-0.05)mm

(2) Requirements

Characteristic impedance : $50\pm2\Omega$ by TDR method Nominal capacitance(Reference value) : 97 pF/m

Dielectric withstand voltage: no breakdown at AC 500V for 1 minutes.

3.1.2 Part No. 20572-001R-08

(1) Description

Inner conductor: AWG#36(7/0.05), Silver plating copper wire
Dielectric core: Fluoro-plastics, diameter 0.40(+0.04,-0.02)mm
Outer conductor: Braid of 0.05mm, diameter 0.65(±0.1)mm,

silver plating copper wire or tin plating copper wire

Jacket : Fluoro-plastics, diameter 0.81(+0.04,-0.03)mm

(2) Requirements

Characteristic impedance : $50\pm3\Omega$ by TDR method Nominal capacitance(Reference value): 96 pF/m

Dielectric withstand voltage: no breakdown at AC 1,000V for 1 minutes.

3.2 Conditions

Voltage: 60 Vr.m.s AC

Operating Temperature: $233\sim363$ K(-40° C $\sim+90^{\circ}$ C)

(Containing temperature rise by current)

Nominal characteristic impedance: 50Ω

Frequency: DC~12 GHz

VSWR	Frequency	0.1~3GHz	3∼6GHz	$6\sim$ 9GHz	9∼12GHz
	Plug:20565-001R-13, 20572-001R-08	1.30 MAX.	1.45 MAX.	1.60 MAX	1.90 MAX
	Receptacle: 20579-001E	1.30 MAX.	1.40 MAX.	1.85 N	MAX.

3.3 Storage Conditions

Storage temperature: 248 to 333K(-25°C to 60°C) Storage humidity: 85% max. (Non-condensing)

4. Test and Performance

Test Condition

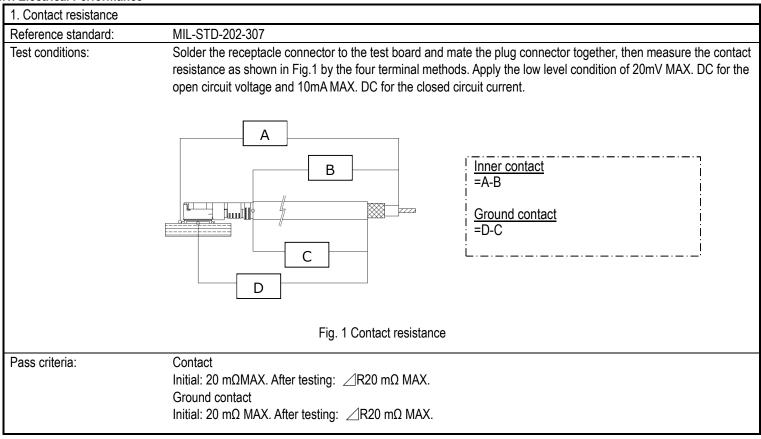
This initial test is equal to it's at shipping condition and unless otherwise specified, all tests and measurements shall be performed under the following conditions in accordance with MIL-STD-202.

Temperature... 288K \sim 308K (15°C \sim 35°C)

Pressure... 866hPa~1066hPa (650mmHg~800mmHg)

Relative humidity... 45~75%R.H.

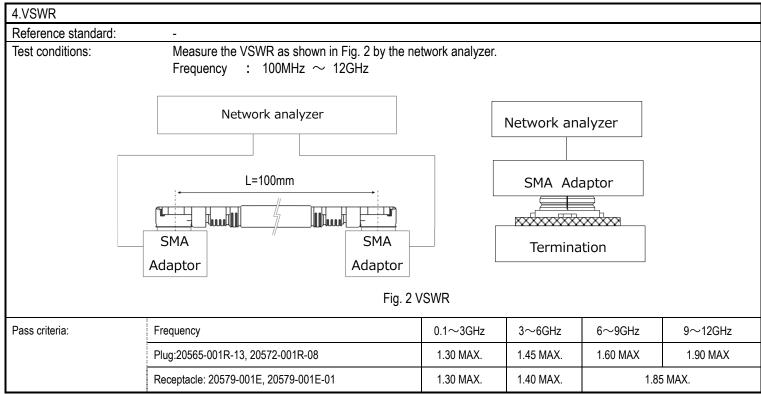
4.1. Electrical Performance



2. Insulation resistance	
Reference standard:	MIL-STD-202-302
Test conditions:	Mate the plug and receptacle connector together, and then apply DC 100 V between the inner contact and the ground contact.
Pass criteria:	Initial: 500 MΩ MIN. After testing: 100 MΩ MIN.

3. Dielectric withstanding voltage		
Reference standard:	MIL-STD-202-301	
Test conditions:	Mate the receptacle and plug connector together, then apply AC 200V(rms) between the neighboring contacts for	
	a minute.	
Pass criteria:	No creeping discharge, flashover, no insulator breakdown shall occur.	

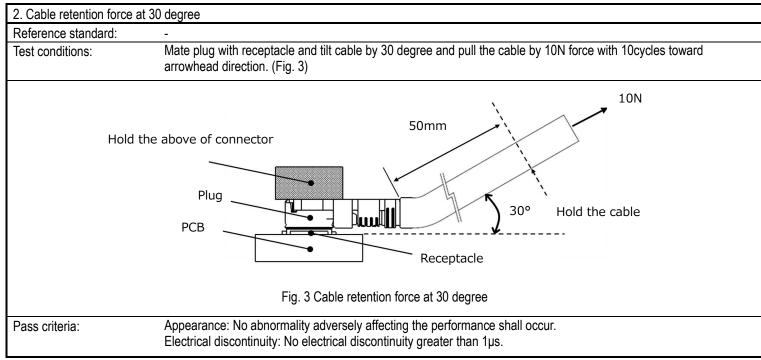
4.1. Electrical Performance

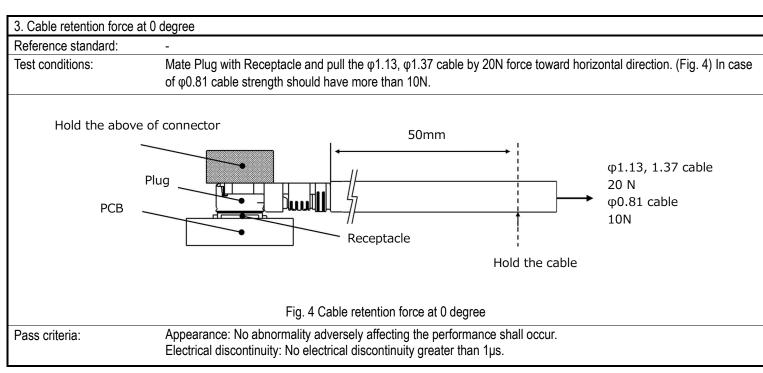


4.2. Mechanical Performance

1. Mating force and Un-ma	ating force
Reference standard:	-
Test conditions:	Solder the receptacle connector to the test board, then place the board and plug on push-on/pull-off machine, measure of initial and mating/unmating 30 cycles at a speed 25±3mm/min. along the mating axis.
Pass criteria:	Mating force Initial: 30 N MAX. 30cycles: 30 N MAX. Unmating force Initial: 20 N MAX., 5 N MIN. 30cycles: 20 N MAX., 3 N MIN

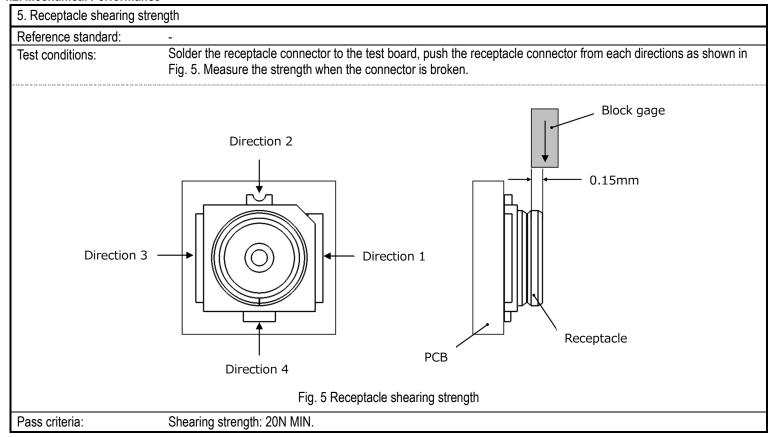
4.2. Mechanical Performance





4. Durability	
Reference standard:	-
Test conditions:	Solder the receptacle connector to the test board, then place the board and plug on the push-on/pull-off machine, and repeat mating and un-mating 30 cycles at a speed 25±3mm/min. along the mating axis.
Pass criteria:	Contact Resistance: Shall meet4.1.1. Appearance: No abnormality adversely affecting the performance shall occur

4.2. Mechanical Performance



6. Vibration	
Reference standard:	-
Test conditions:	Apply the following vibration to the mating connector.
	During the testing, run 100mA DC to check electrical discontinuity.
	Frequency: 10Hz →100Hz → 10Hz / approx 15minutes.
	Half amplitude, Peak value of acceleration: 1.5mm or 59m/s2 (6G)
	Directions, cycle: 3 mutually perpendicular direction, 5 cycles (approx 75minutes.) for each direction.
Pass criteria:	Contact resistance: Shall meet 4.1.1.
	Electrical discontinuity: No electrical discontinuity greater than 1µs shall occur.
	Appearance: No abnormality adversely affecting the performance shall occur

7.Shock		
Reference standard:	MIL-STD-202-213, Condition A.	
Test conditions:	Solder the receptacle connector to the test board and then apply the following shock to the mating connector.	
	During the testing, run 100mA D	C to check electrical discontinuity.
	MAX.G: 50G	Directions: 6 mutually perpendicular direction
	Duration: 11msec	Cycle: 3 cycles about each direction
	Wave Form: Half Sinusoidal	, ,
Pass criteria:	Contact resistance: Shall meet 4.1.1.	
	Electrical discontinuity: No electrical discontinuity greater than 1µs shall occur.	
	Appearance: No abnormality ad	versely affecting the performance shall occur

4.3. Environmental Performance

1.Thermal shock	
Reference standard:	MIL-STD-202-107, Condition A.
Test conditions:	Solder the receptacle connector to the test board, then mate plug connector, and expose them to the following environment. Temperature: 218K(-55°C),30min.→358K(85°C),30min. Transition time: 5min. MAX. No. of cycles: 5 cycles
Pass criteria:	Contact resistance: Shall meet 4.1.1. Insulation resistance: Shall meet 4.1.2. Dielectric withstanding voltage: Shall meet 4.1.3. Appearance: No abnormality adversely affecting the performance shall occur

2. High temperature life	
Reference standard:	MIL-STD-202-108, Condition B.
Test conditions:	Solder the receptacle connector to the test board, then mate plug connector, and expose them to the following
	environment.
	Temperature: 363±2K (90±2°C)
	Duration: 96 hours
Pass criteria:	Contact resistance: Shall meet 4.1.1.
	Appearance: No abnormality adversely affecting the performance shall occur

3. Humidity(Steady state)	
Reference standard:	MIL-STD-202-103, Condition A.
Test conditions:	Solder the receptacle connector to the test board, then mate plug connector, and expose them to the following environment. Temperature: 313±2K (40±2°C) Humidity: 90~95%RH Duration: 96 hours
Pass criteria:	Contact resistance: Shall meet 4.1.1. Insulation resistance: Shall meet 4.1.2. Dielectric withstanding voltage: Shall meet 4.1.3. Appearance: No abnormality adversely affecting the performance shall occur

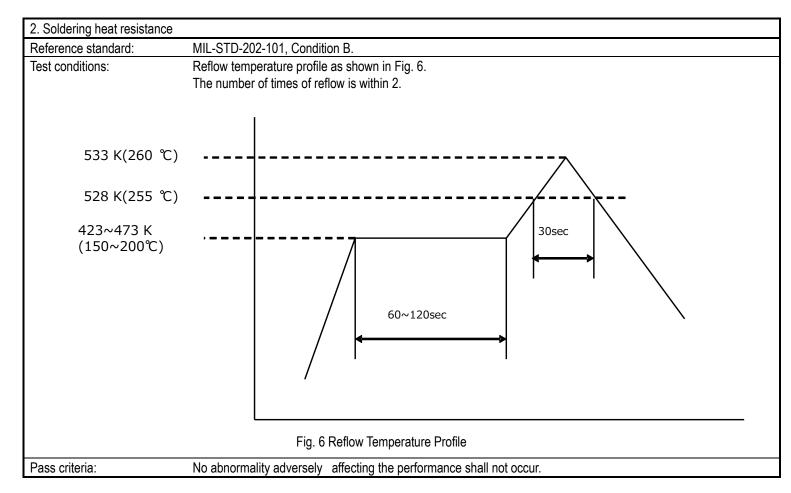
4. Saltwater spray	
Reference standard:	MIL-STD-202-101, Condition B
Test conditions:	Solder the receptacle connector to the test board, then mate plug connector, and expose them to the following environment.
	Temperature: 308±2K (35±2°C)
	Salt water density: 5±1% [by weight]
	Duration: 48 hours
Pass criteria:	Contact resistance: Shall meet 4.1.1.
	Appearance: No abnormality adversely affecting the performance shall occur

4.3. Environmental Performance

5. H₂S gas	
Reference standard:	-
Test conditions:	Solder the receptacle connector to the test board, then mate plug connector, and expose them to the following environment. Temperature: 313±2K (40±2°C) Relative humidity: 80±5%RH Gas: H ₂ S 3±1ppm Duration: 48 hours
Pass criteria:	Contact resistance: Shall meet 4.1.1. Appearance: No abnormality adversely affecting the performance shall occur

4.4.Others

1. Solder ability							
Reference standard:	MIL-STD-202-208						
Test conditions:	Dip the solder tine of the contact in the solder bath at 518±5K (245±5°C) for 5±0.5seconds after immersing the tine in the flux of RMA or R type for 5 to 10 seconds.						
Pass criteria:	The surface of the dipped contact must become 95% wet and the non-wetted pinholes must not accumulate in one area but be distributed and must be less than 5% of the contact area to be soldered.						



4.5 Test Sequence and Specimen Quantity

Table 1 Test Sequence and Sample Quantity

	Group															
Test Item	A	В	С	D	Е	F	G	Н	J	К	L	М	N	Р	Q	R
Contact resistance						1,3		1,3	1,3	1,5	1,3	1,5	1,3	1,3		
Insulation resistance										2,6		2,6				
Dielectric withstanding voltage	1									3,7		3,7				
VSWR		1														
Mating force Un-mating force			1													
Cable retention force at 30 degree				1												
Cable retention force at 0 degree					1											
Durability						2										
Shearing strength							1									
Vibration								2								
Shock									2							
Thermal shock										4						
High temperature life											2					
Humidity (Steady State)												4				
Saltwater spray													2			
H₂S gas														2		
Solder ability															1	
Soldering heat resistance																1
Specimen quantity.	10 pcs.	10 pcs.	10 pcs.	10 pcs.	10 pcs.	10 pcs.	12 pcs.	10 pcs.	10 pcs	10 pcs						

*Numbers indicate sequence in which tests are performed.

5. Recommended Metal Mask

Refer to drawing for the recommended metal mask thickness and opening dimension.